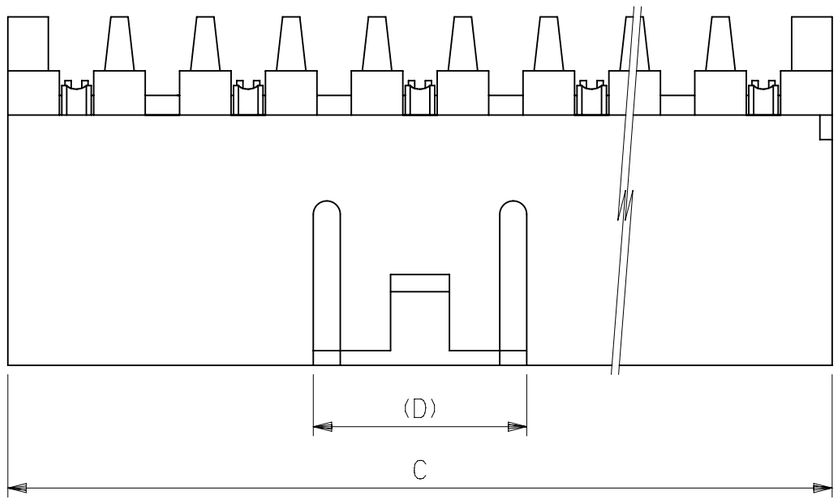
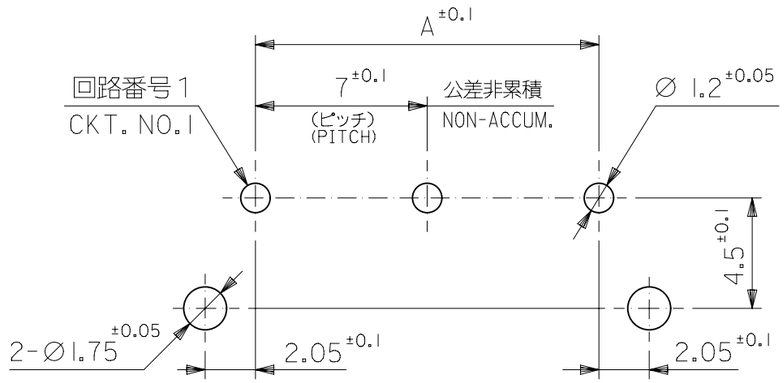
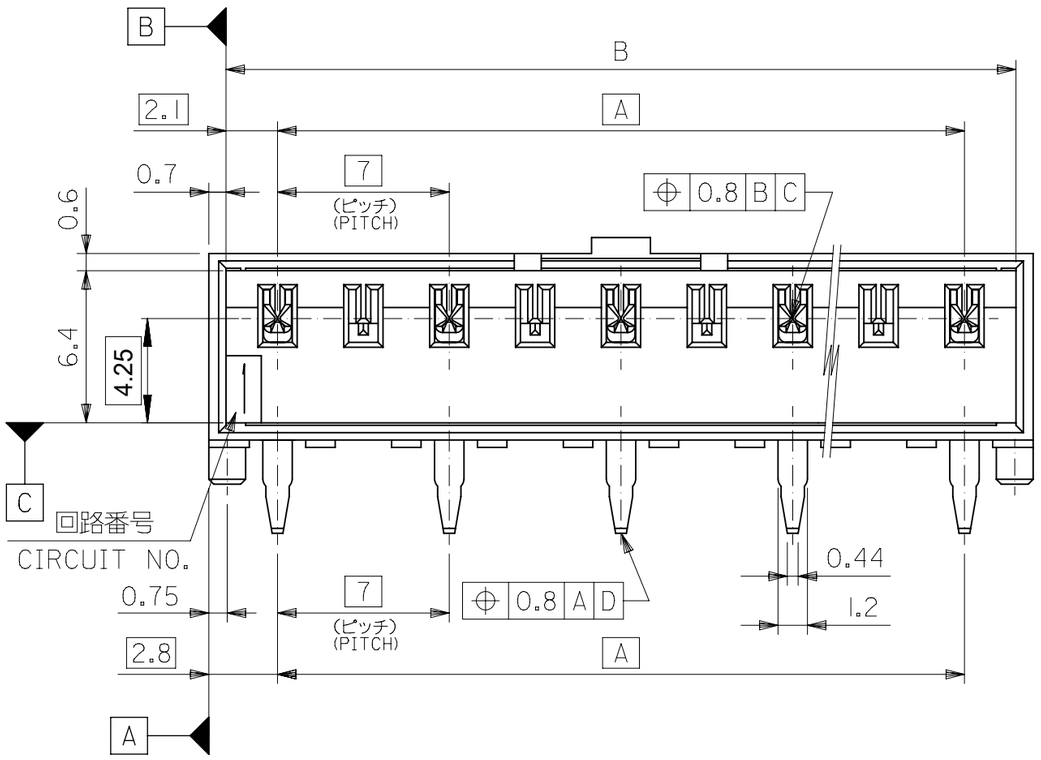
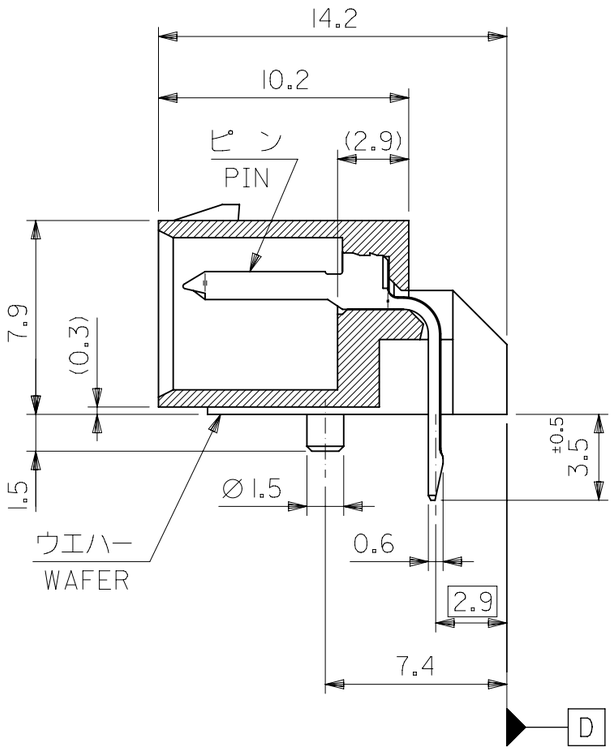




基板取付穴推奨寸法（参考）（t＝1．6）

RECOMMENDED P.C. BOARD HOLE DIM. (REF.)





8.7	33.6	32.2	28.0	53266-0529	5
8.7	26.6	25.2	21.0	-0429	4
8.7	19.6	18.2	14.0	-0329	3
6.1	12.6	11.2	7.0	53266-0229	2
(D)	C	B	A	TRAY PACKAGE ORDER No. オーダー番号	CKT. 極数

53266-**29 MODEL NO.

注記 NOTES

1. 嵌合相手：51067 シリーズ
   MATE WITH : 51067 SERIES
2. 材質
   MATERIAL
   ウエハー：PBTP（ガラス15%入り）、UL94V-0
   WAFER : PBTP (G.F 15%), UL94V-0
   ピン　：53266-**29 [黄銅、ニッケル下地、錫メッキ（t=0.254）]
   [BRASS, OVER NICKEL PLATED, TIN (t=0.254)]
3. 本製品は53266-**20の鉛フリー品である。
   THIS PRODUCT IS LEAD FREE OF 53266-**20.

GENERAL TOLERANCES (UNLESS SPECIFIED)	
10 UNDER	± 0.2
10 OVER 30 UNDER	± 0.25
30 OVER	± 0.3
ANGULAR	±3 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

GENERAL TOLERANCES (UNLESS SPECIFIED)	
ANGULAR TOL	± 3.0 °
4 PLACES	± 0.2
3 PLACES	± 0.25
2 PLACES	± 0.3
1 PLACE	±
0 PLACES	±

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

DIMENSION UNITS: mm　SCALE: ---

THIRD ANGLE PROJECTION　DRAWING: A3-SIZE　SERIES: 53266

CURRENT REV DESC: REMOVED OBSOLETED PART NUMBERS AS PER PCN#515181

EC NO: 794166
DRWN: VISHAH2 2024/06/04
CHK'D: GGA 2024/08/20
APPR: GGA 2024/08/20

INITIAL REVISION:
DRWN: M. NAGATA 2004/05/19
APPR: M. SASAO 2004/05/19

molex

7.0 WIRE TO BOARD CONN.
WAFER ASS'Y (R/A) -LEAD FREE-

PRODUCT CUSTOMER DRAWING

DOCUMENT NUMBER	DOC TYPE	DOC PART	REVISION
SD-53266-002	PSD	001	B1

MATERIAL NUMBER	CUSTOMER	SHEET NUMBER
SEE TABLE	GENERAL MARKET	1 OF 1

DOCUMENT STATUS	P1	RELEASE DATE	2024/08/20 07:34:20

FORMAT: master-tb-prod-A3
REVISION: J1
DATE: 2021/05/01